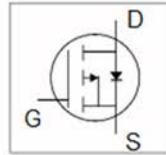
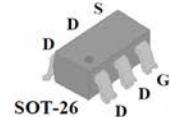


- Simple Drive Requirement
- Small Package Outline
- Surface Mount Device
- RoHS Compliant & Halogen-Free



BVDSS	-20V
RDS(ON)typ	27mΩ
ID	-6A



Description

KE2305 is from Kingeavy innovated design and silicon process technology to achieve the lowest possible on- resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

Absolute Maximum Ratings@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-20	V
V _{GS}	Gate-Source Voltage	±12	V
I _D -Continuous	Drain Current, V _{GS} @ 4.5V	-6	A
I _{DM}	Pulsed Drain Current ₂	-17	A
P _D @T _A =25°C	Total Power Dissipation ₃	1.6	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R _{thj-a}	Maximum Thermal Resistance, Junction-ambient ₃	63	°C/W

Electrical Characteristics@ $T_j=25\text{ }^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{VGS}=0\text{V}, \text{ID}=250\mu\text{A}$	-20	-	-	V
$\text{RDS}(\text{ON})$	Static Drain-Source On-Resistance	$\text{VGS}=4.5\text{V}, \text{ID}=-5\text{A}$	-	27	35	$\text{m}\Omega$
		$\text{VGS}=-2.5\text{V}, \text{ID}=-4.0\text{A}$	-	38	53	$\text{m}\Omega$
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$\text{VDS}=\text{VGS}, \text{ID}=250\mu\text{A}$	-0.4	-	-1	V
I_{DSS}	Drain-Source Leakage Current	$\text{VDS}=-8\text{V}, \text{VGS}=0\text{V}$	-	-	-1	μA
I_{GSS}	Gate-Source Leakage	$\text{VGS}=\pm 8\text{V}, \text{VDS}=0\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge	$\text{ID}=-4\text{A}$ $\text{VDS}=-10\text{V}$ $\text{VGS}=-4.5\text{V}$	-	13	-	nC
Q_{gs}	Gate-Source Charge		-	1.7	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge		-	4	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$\text{VDS}=-10\text{V}$ $\text{ID}=3.3\text{A}$ $\text{RG}=3\Omega$ $\text{VGS}=-4.5\text{V}, \text{RL}=2.5\Omega$	-	10	-	ns
t_r	Rise Time		-	17	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		-	45	-	ns
t_f	Fall Time		-	33	-	ns
C_{iss}	Input Capacitance	$\text{VGS}=0\text{V}$ $\text{VDS}=-10\text{V}$ $f=1.0\text{MHz}$	-	1050	-	pF
C_{oss}	Output Capacitance		-	180	-	pF
Crss	Reverse Transfer Capacitance		-	160	-	pF
R_g	Gate Resistance	$f=1.0\text{MHz}$	-	11.5	-	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$\text{IS}=3\text{A}, \text{VGS}=0\text{V}$	-	-0.75	-1.3	V

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² 2oz copper pad of FR4 board, $t \leq 10\text{sec}$; 300°C/W when mounted on min. copper pad.

Typical Performance Characteristics

Figure 1: Output Characteristics

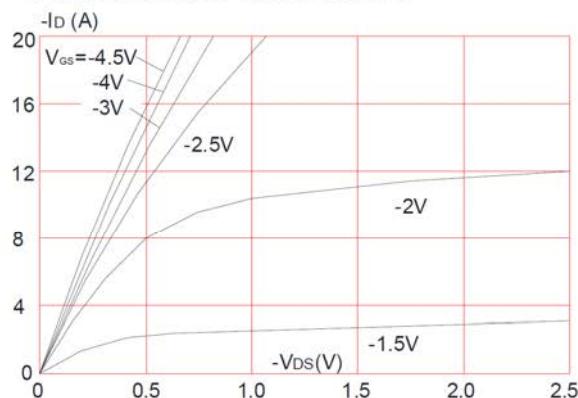


Figure 3: On-resistance vs. Drain Current

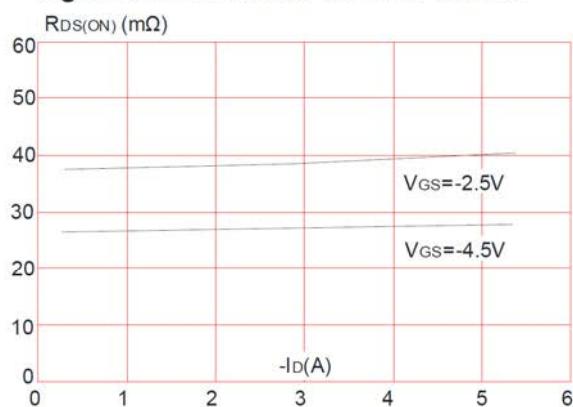


Figure 5: Gate Charge Characteristics

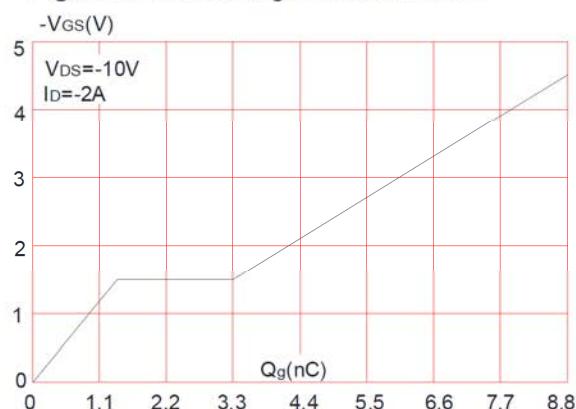


Figure 2: Typical Transfer Characteristics

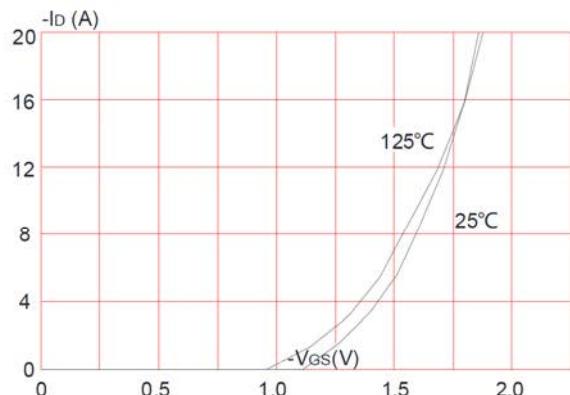


Figure 4: Body Diode Characteristics

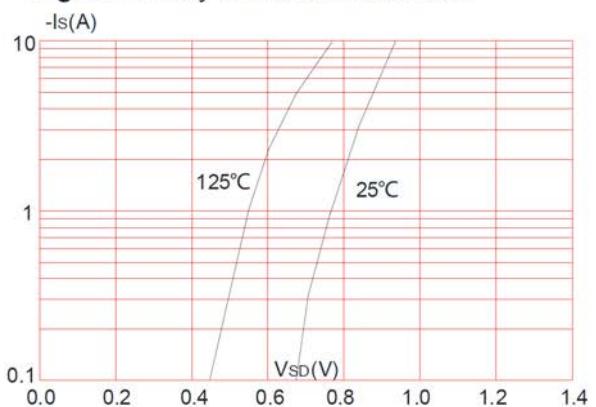


Figure 6: Capacitance Characteristics

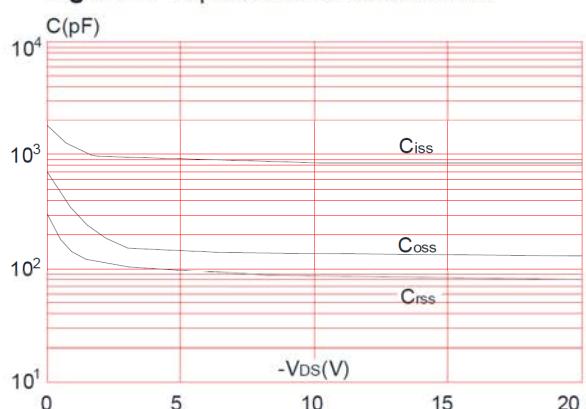


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

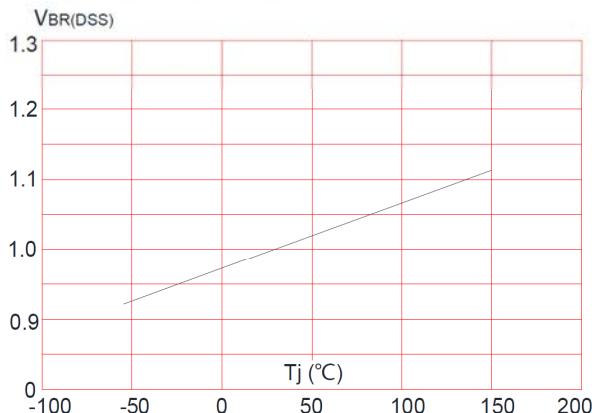


Figure 9: Maximum Safe Operating Area

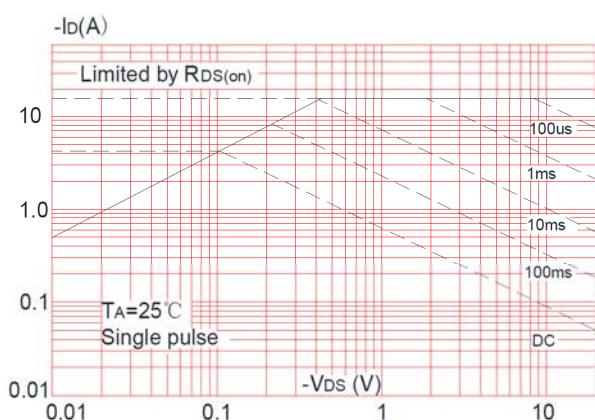


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

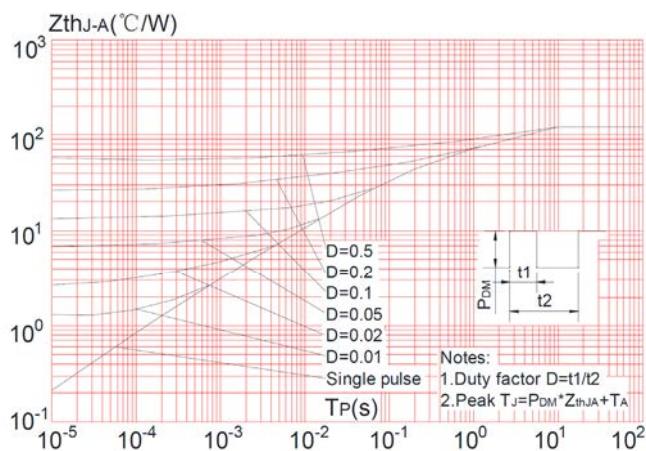


Figure 8: Normalized on Resistance vs. Junction Temperature

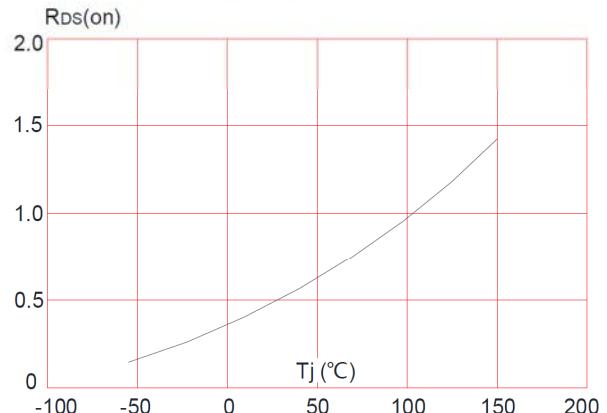
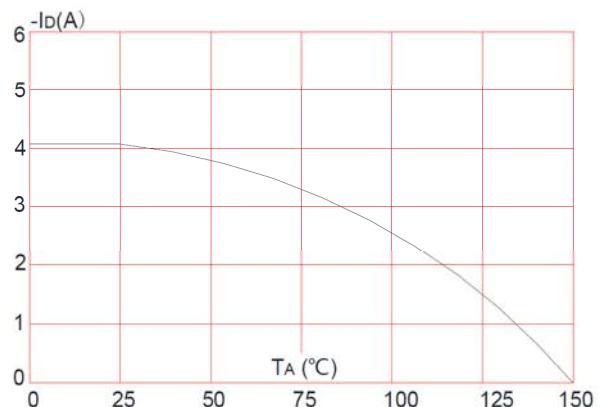
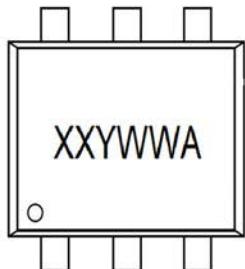


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature



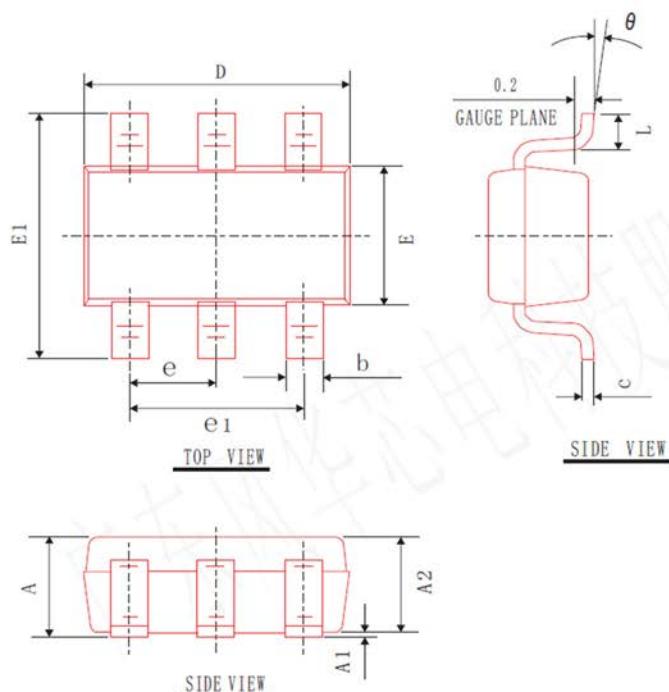
Marking Information

KE PN	PN code
<u>KE2305TBU</u>	B 7



Package	SOT	Description
XX	PN code	
Y	Year	0-9,A-Z I=2023 J=2024 ...等
WW	Weeks	Ex.2019 -- 10/27=44weeks, 11/3=45weeks
A	Assembly	Assembly B=先科

Package Outline : SOT-26



COMMON DIMENSIONS
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	—	—	1.20
A1	0.00	0.05	0.10
A2	1.00	1.10	1.20
b	0.30	0.40	0.50
c	0.119	0.127	0.135
e1	1.80	1.90	2.00
D	2.80	2.90	3.00
E	1.50	1.60	1.70
E1	2.60	2.80	3.00
L	0.30	0.45	0.60
θ	0°	4°	8°
e	0.95BSC		